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IN THE UNITED	STATES PATENT	AND TRADEMARK	OFFICE

In re Patent application of

Shunpei YAMAZAKI et al.

Serial No. 09/436,984

Filed: November 9, 1999

Part Unit: 2823

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Examiner: W. Coleman

For: SEMICONDUCTOR DEVICE AND

MANUFACTURING METHOD THEREOF

Date: February 13, 2002

PRELIMINARY AMENDMENT

Commissioner for Patents Washington, D.C. 20231

Sir:

Please preliminarily amend the subject application as follows.

IN THE CLAIMS:

RECEIVED

Please add new claims 32-54 as follows:

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OFFICE OF PETITIONS

--32. A semiconductor device comprising:

a semiconductor film formed on an insulating surface;

a channel forming region in the semiconductor film;

a gate insulating film formed on the semiconductor film;

a gate electrode formed over the channel forming region with the gate insulating film interposed therebetween;

a pair of side walls adjacent to side surfaces of the gate electrode;

a pair of first impurity regions doped with an N-type impurity at a first concentration and formed in the semiconductor film with the channel forming region extending therebetween wherein the pair of side walls overlap the pair of first impurity regions; and

a pair of second impurity regions doped with an N-type impurity at a second concentration greater than the first concentration and formed in the semiconductor film adjacent to the pair of first impurity regions; and

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